

NextPower 100 V, 5.6 mOhm N-channel MOSFET in LFPAK56 package

11 October 2022

Product data sheet

#### 1. General description

NextPower 100 V, standard level gate drive MOSFET. Qualified to 175  $^\circ\text{C}$  and recommended for industrial and consumer applications.

## 2. Features and benefits

- Low Q<sub>rr</sub> for higher efficiency and lower spiking
- Low Q<sub>G</sub> × R<sub>DSon</sub> FOM for high efficiency switching applications
- 115 A I<sub>D(max)</sub> demonstrated continuous current rating
- Strong avalanche energy rating (E<sub>AS</sub>)
- Avalanche rated and 100% tested
- Ha-free and RoHS compliant LFPAK56 package
- Wave-solderable LFPAK56 package

## 3. Applications

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- Synchronous rectifier in AC-DC and DC-DC
- Primary side switch 48 V DC-DC
- BLDC motor control
- USB-PD and mobile fast-charge adapters
- Flyback and resonant topologies
- Full-bridge and half-bridge applications

## 4. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	25 °C ≤ T <sub>j</sub> ≤ 175 °C	-	-	100	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; <u>Fig. 2</u>	-	-	115	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; <u>Fig. 1</u>	-	-	238	W
Tj	junction temperature		-55	-	175	°C
Static chara	acteristics					
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C; Fig. 12	-	4.5	5.6	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 100 °C; Fig. 13	-	6.9	8.9	mΩ
Dynamic ch	naracteristics	· · · ·				
Q <sub>GD</sub>	gate-drain charge	$I_D$ = 25 A; $V_{DS}$ = 50 V; $V_{GS}$ = 10 V;	3.5	11.8	27.1	nC
Q <sub>G(tot)</sub>	total gate charge	T <sub>j</sub> = 25 °C; <u>Fig. 14</u> ; <u>Fig. 15</u>	32	64	95	nC

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Avalanche r	uggedness						
E <sub>DS(AL)S</sub>	non-repetitive drain- source avalanche energy	$ \begin{array}{l} {\sf I}_{D} = 44.1 \; {\sf A}; \; {\sf V}_{sup} \leq \; 100 \; {\sf V}; \; {\sf R}_{GS} = 50 \; \Omega; \\ {\sf V}_{GS} = 10 \; {\sf V}; \; {\sf T}_{j(init)} = 25 \; {\rm ^{\circ}C}; \; unclamped; \\ {\sf t}_{p} = 80 \; \mu {\sf s}; \; \underline{{\sf Fig. 4}} \end{array} $	[1]	-	-	231	mJ
Source-drai	n diode		•				
Q <sub>r</sub>	recovered charge	$\label{eq:IS} \begin{array}{l} {\sf I}_{\sf S} = 25 \; {\sf A}; \; {\sf dI}_{\sf S} / {\sf dt} = -100 \; {\sf A} / {\sf \mu}{\sf s}; \; {\sf V}_{\sf GS} = 0 \; {\sf V}; \\ {\sf V}_{\sf DS} = 50 \; {\sf V}; \; {\sf T}_{\sf j} = 25 \; {\rm ^{\circ}C}; \; \underline{{\sf Fig. 18}} \end{array}$		-	30	-	nC

[1] Protected by 100% test

## 5. Pinning information

Table 2. Pinning information								
Pin	Symbol	Description	Simplified outline	Graphic symbol				
1	S	source	mb					
2	S	source		D				
3	S	source	a					
4	G	gate		G_(F] ▲)				
mb	D	mounting base; connected to drain	LFPAK56; Power- SO8 (SOT669)	mbb076 S				

## 6. Ordering information

#### Table 3. Ordering information

Type number         Package				
	Name	Description	Version	
PSMN5R5-100YSF	LFPAK56; Power-SO8	plastic, single-ended surface-mounted package; 4 terminals	SOT669	

## 7. Marking

Table 4. Marking codes					
Type number	Marking code				
PSMN5R5-100YSF	5F5S10Y				

## 8. Limiting values

#### Table 5. Limiting values

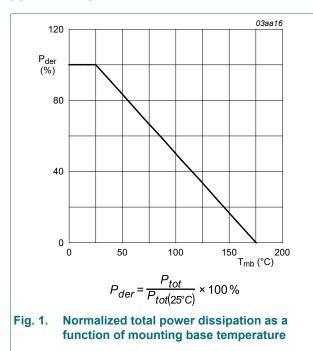
In accordance with the Absolute Maximum Rating System (IEC 60134).

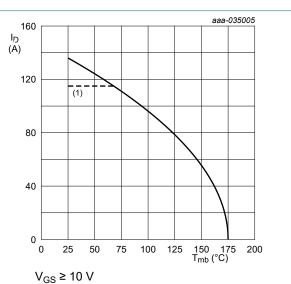
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	25 °C ≤ T <sub>j</sub> ≤ 175 °C	-	100	V
V <sub>DGR</sub>	drain-gate voltage	$25 \text{ °C} \le \text{T}_{j} \le 175 \text{ °C}; \text{R}_{\text{GS}} = 20 \text{ k}\Omega$	-	100	V
V <sub>GS</sub>	gate-source voltage		-20	20	V
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; <u>Fig. 1</u>	-	238	W
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; <u>Fig. 2</u>	-	115	A
		V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 100 °C; <u>Fig. 2</u>	-	96	A

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Symbol	Parameter	Conditions		Min	Мах	Unit
I <sub>DM</sub>	peak drain current	pulsed; t <sub>p</sub> ≤ 10 µs; T <sub>mb</sub> = 25 °C; <u>Fig. 3</u>		-	544	А
T <sub>stg</sub>	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
T <sub>sld(M)</sub>	peak soldering temperature			-	260	°C
Source-drai	n diode					
I <sub>S</sub>	source current	T <sub>mb</sub> = 25 °C		-	115	А
I <sub>SM</sub>	peak source current	pulsed; $t_p \le 10 \ \mu s$ ; $T_{mb} = 25 \ ^{\circ}C$		-	544	А
Avalanche r	uggedness					
E <sub>DS(AL)S</sub>	non-repetitive drain- source avalanche energy	$ \begin{split} &I_{D} = 44.1 \text{ A};  V_{sup} \leq \ 100 \text{ V};  R_{GS} = 50 \ \Omega; \\ &V_{GS} = 10 \text{ V};  T_{j(init)} = 25 \ ^{\circ}\text{C};  unclamped; \\ &t_{p} = 80 \ \mu\text{s};  \overline{Fig. 4} \end{split} $	[1]	-	231	mJ
I <sub>AS</sub>	non-repetitive avalanche current	$V_{sup}$ = 100 V; $V_{GS}$ = 10 V; $T_{j(init)}$ = 25 °C; R <sub>GS</sub> = 50 Ω; <u>Fig. 4</u>	[1]	-	44.1	A

[1] Protected by 100% test

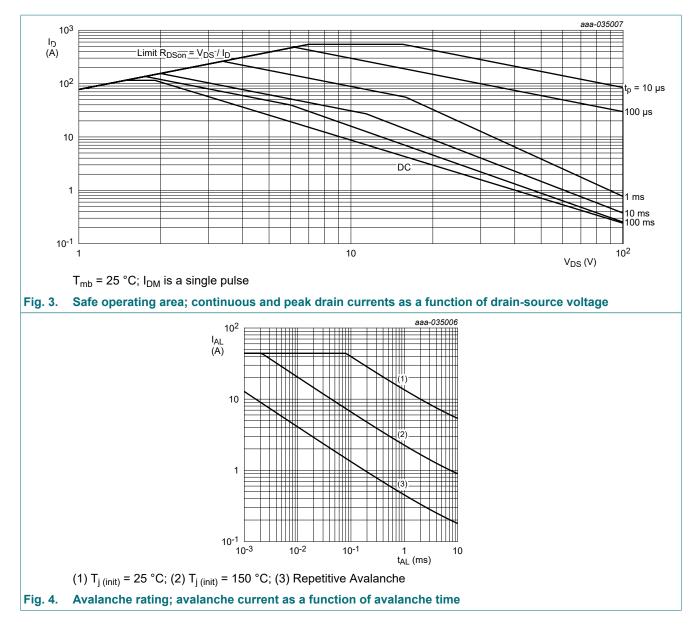




(1) 115 A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

Fig. 2. Continuous drain current as a function of mounting base temperature

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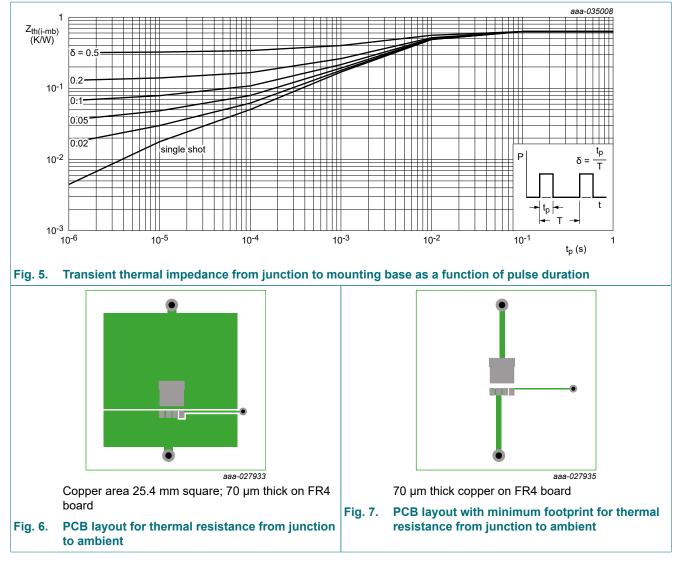


#### 9. Thermal characteristics

#### Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	<u>Fig. 5</u>	-	0.56	0.63	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	Fig. 6	-	42	-	K/W
		<u>Fig. 7</u>	-	85	-	K/W

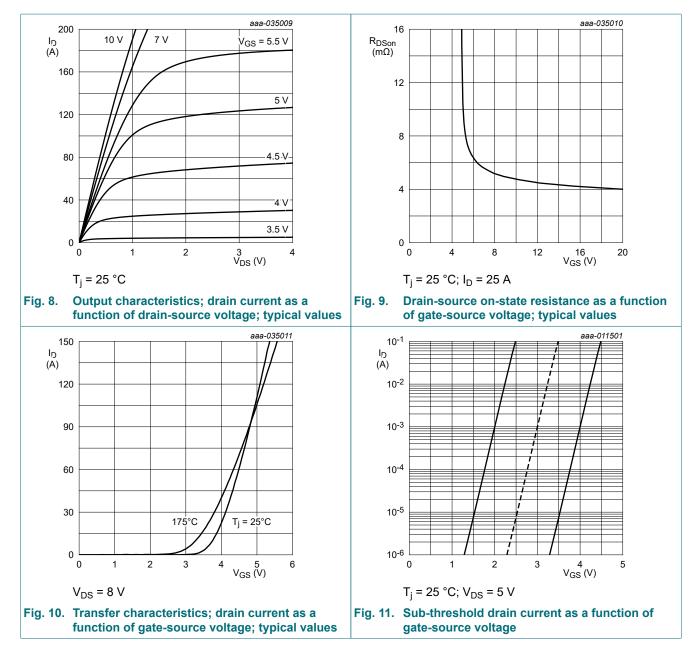
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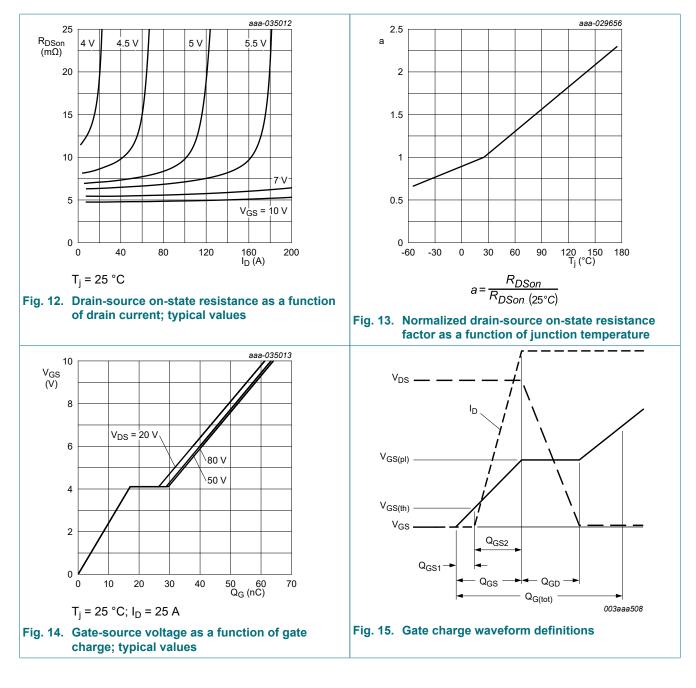
## **10. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static charac	teristics	· · ·				_
V <sub>(BR)DSS</sub>	drain-source	I <sub>D</sub> = 250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	100	-	-	V
	breakdown voltage	I <sub>D</sub> = 250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = -55 °C	90	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	I <sub>D</sub> = 1 mA; V <sub>DS</sub> =V <sub>GS</sub> ; T <sub>j</sub> = 25 °C; <u>Fig. 11</u>	2	2.7	4	V
		I <sub>D</sub> = 1 mA; V <sub>DS</sub> =V <sub>GS</sub> ; T <sub>j</sub> = 175 °C	-	1.6	-	V
		I <sub>D</sub> = 1 mA; V <sub>DS</sub> =V <sub>GS</sub> ; T <sub>j</sub> = -55 °C	-	3	-	V
$\Delta V_{GS(th)} / \Delta T$	gate-source threshold voltage variation with temperature	25 °C ≤ T <sub>j</sub> ≤ 150 °C	-	-6.8	-	mV/K
I <sub>DSS</sub>	drain leakage current	V <sub>DS</sub> = 100 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	0.04	1	μA
		V <sub>DS</sub> = 100 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 125 °C	-	13	100	μA
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = 20 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	2	100	nA
		V <sub>GS</sub> = -20 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	2	100	nA

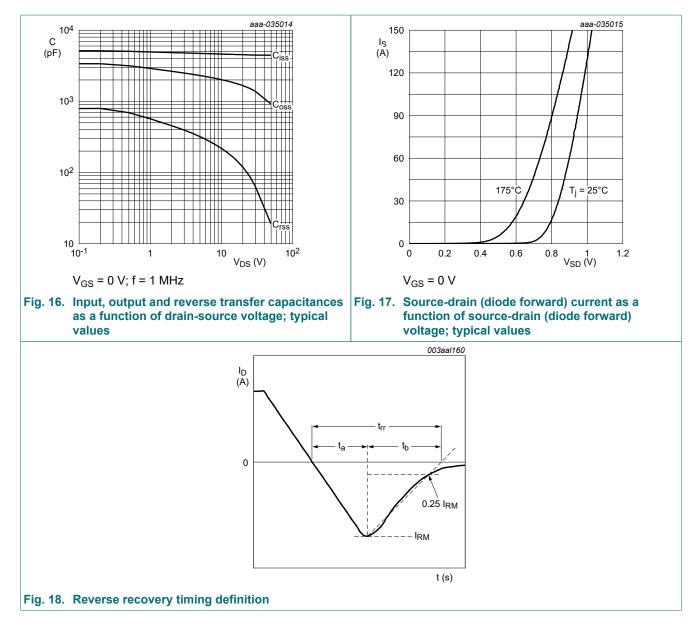
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C; Fig. 12	-	4.5	5.6	mΩ
		V <sub>GS</sub> = 7 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C; <u>Fig. 12</u>	-	5	8.4	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 100 °C; <u>Fig. 13</u>	-	6.9	8.9	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 175 °C; <u>Fig. 13</u>	-	9.8	12.7	mΩ
R <sub>G</sub>	gate resistance	f = 1 MHz; T <sub>j</sub> = 25 °C	0.5	1	2	Ω
Dynamic ch	aracteristics	11				
Q <sub>G(tot)</sub>	total gate charge	$I_D = 25 \text{ A}; V_{DS} = 50 \text{ V}; V_{GS} = 10 \text{ V};$ $T_j = 25 \text{ °C}; \overline{Fig. 14}; \overline{Fig. 15}$	32	64	95	nC
		$I_D = 0 \text{ A}; V_{DS} = 0 \text{ V}; V_{GS} = 10 \text{ V};$ $T_j = 25 \text{ °C}$	-	32	-	nC
Q <sub>GS</sub>	gate-source charge	$I_{D} = 25 \text{ A}; V_{DS} = 50 \text{ V}; V_{GS} = 10 \text{ V};$ $T_{j} = 25 \text{ °C}; Fig. 14; Fig. 15$	10.3	17.1	24	nC
Q <sub>GS(th)</sub>	pre-threshold gate- source charge		-	12	-	nC
Q <sub>GS(th-pl)</sub>	post-threshold gate- source charge		-	4.8	-	nC
Q <sub>GD</sub>	gate-drain charge	-	3.5	11.8	27.1	nC
V <sub>GS(pl)</sub>	gate-source plateau voltage	I <sub>D</sub> = 25 A; V <sub>DS</sub> = 50 V; T <sub>j</sub> = 25 °C; Fig. 14; Fig. 15	-	4.1	-	V
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = 50 V; V <sub>GS</sub> = 0 V; f = 1 MHz;	2674	4456	6238	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C; <u>Fig. 16</u>	548	914	1462	pF
C <sub>rss</sub>	reverse transfer capacitance		2	19	49	pF
d(on)	turn-on delay time	$V_{DS} = 50 \text{ V}; \text{ R}_{L} = 2 \Omega; \text{ V}_{GS} = 10 \text{ V};$	-	16	-	ns
r	rise time	R <sub>G(ext)</sub> = 5 Ω; T <sub>j</sub> = 25 °C	-	14	-	ns
d(off)	turn-off delay time		-	42	-	ns
f	fall time		-	21	-	ns
Source-drai	n diode	· · · · ·	1		_	
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = 25 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C; <u>Fig. 17</u>	-	0.82	1	V
rr	reverse recovery time	$I_{S} = 25 \text{ A}; \text{ d}I_{S}/\text{d}t = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V};$	-	37	-	ns
Q <sub>r</sub>	recovered charge	V <sub>DS</sub> = 50 V; T <sub>i</sub> = 25 °C; <u>Fig. 18</u>		30	-	nC



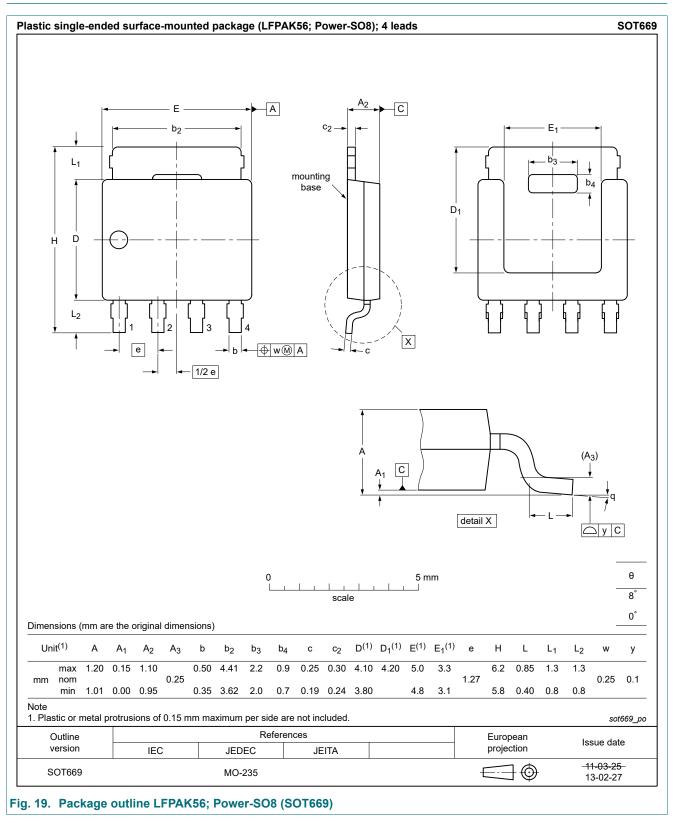
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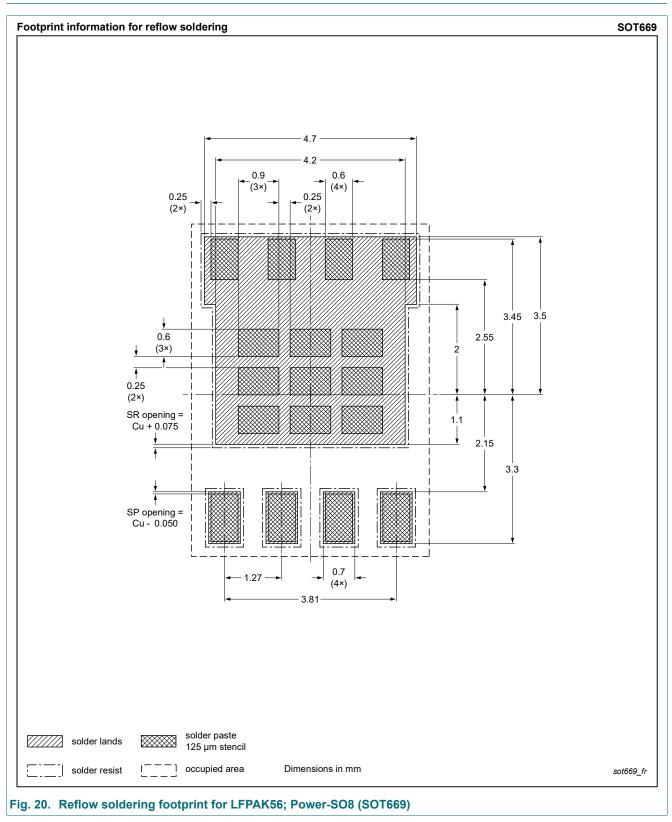
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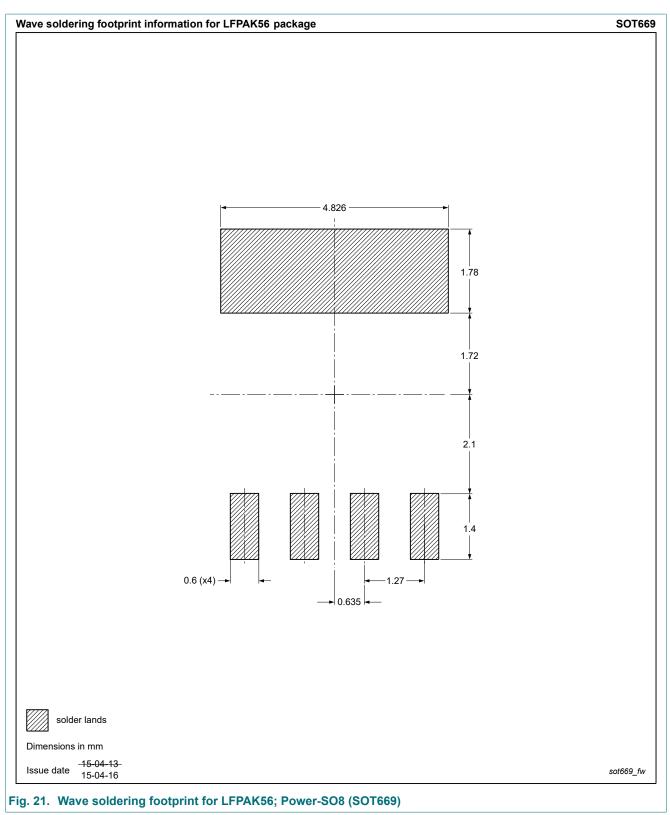


## **11. Package outline**



## 12. Soldering





## 13. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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